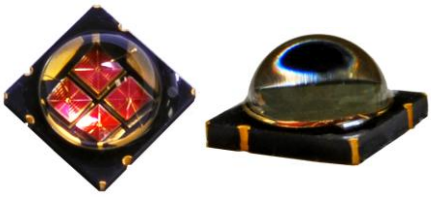
High Luminous Efficacy
Red LED Emitter

LZ4-00R100



Key Features

- High Luminous Efficacy 10W Red LED
- Ultra-small foot print – 7.0mm x 7.0mm
- Surface mount ceramic package with integrated glass lens
- Very low Thermal Resistance (1.1°C/W)
- Individually addressable die
- Very high Luminous Flux density
- JEDEC Level 1 for Moisture Sensitivity Level
- Autoclave compliant (JEDEC JESD22-A102-C)
- Lead (Pb) free and RoHS compliant
- Reflow solderable (up to 6 cycles)
- Emitter available on Serially Connected MCPCB (optional)

Typical Applications

- Emergency lighting
- Strobe and warning signs
- Architectural Lighting
- Automotive and Marine lighting
- Airfield lighting and signs
- Buoys
- Beacons
- Machine vision

Description

The LZ4-00R100 Red LED emitter provides 10W power in an extremely small package. With a 7.0mm x 7.0mm ultra-small footprint, this package provides exceptional luminous flux density. LED Engin's LZ4-00R100 LED offers ultimate design flexibility with individually addressable die. The patent-pending design has unparalleled thermal and optical performance. The high quality materials used in the package are chosen to optimize light output and minimize stresses which results in monumental reliability and lumen maintenance. The robust product design thrives in outdoor applications with high ambient temperatures and high humidity.

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Part number options

Base part number

Part number	Description
LZ4-00R100-xxxx	LZ4 emitter
LZ4-40R100-xxxx	LZ4 emitter on Standard Star 1 channel MCPCB

Bin kit option codes

R1, Red (623nm)			
Kit number suffix	**Min flux Bin**	**Color Bin Range**	**Description**
0000	R	R2 – R2	full distribution flux; full distribution wavelength

Notes:
1. Default bin kit option is -0000

Luminous Flux Bins

Table 1:

Bin Code	Minimum Luminous Flux (Φ_V) @ I_F = 700mA[1,2] (lm)	Maximum Luminous Flux (Φ_V) @ I_F = 700mA[1,2] (lm)
R	285	356
S	356	445
T	445	556

Notes for Table 1:
1. Luminous flux performance guaranteed within published operating conditions. LED Engin maintains a tolerance of ± 10% on flux measurements.
2. Future products will have even higher levels of luminous flux performance. Contact LED Engin Sales for updated information.

Dominant Wavelength Bins

Table 2:

Bin Code	Minimum Dominant Wavelength (λ_D) @ I_F = 700mA[1,2] (nm)	Maximum Dominant Wavelength (λ_D) @ I_F = 700mA[1,2] (nm)
R2	618	630

Notes for Table 2:
1. Dominant wavelength is derived from the CIE 1931 Chromaticity Diagram and represents the perceived hue.
2. LED Engin maintains a tolerance of ± 1.0nm on dominant wavelength measurements.

Forward Voltage Bins

Table 3:

Bin Code	Minimum Forward Voltage (V_F) @ I_F = 700mA[1,2] (V)	Maximum Forward Voltage (V_F) @ I_F = 700mA[1,2] (V)
0	8.96	11.60

Notes for Table 3:
1. LED Engin maintains a tolerance of ± 0.04V for forward voltage measurements.
2. Forward Voltage is binned with all four LED dice connected in series.

Absolute Maximum Ratings

Table 4:

Parameter	Symbol	Value	Unit
DC Forward Current at T_{jmax}=100°C [1]	I_F	1200	mA
DC Forward Current at T_{jmax}=125°C [1]	I_F	1000	mA
Peak Pulsed Forward Current [2]	I_{FP}	1500	mA
Reverse Voltage	V_R	See Note 3	V
Storage Temperature	T_{stg}	-40 ~ +125	°C
Junction Temperature	T_J	125	°C
Soldering Temperature [4]	T_{sol}	260	°C
Allowable Reflow Cycles		6	
Autoclave Conditions [5]		121°C at 2 ATM, 100% RH for 168 hours	
ESD Sensitivity [6]		> 8,000 V HBM Class 3B JESD22-A114-D	

Notes for Table 4:
1. Maximum DC forward current (per die) is determined by the overall thermal resistance and ambient temperature. Follow the curves in Figure 10 for current derating.
2: Pulse forward current conditions: Pulse Width ≤ 10msec and Duty Cycle ≤ 10%.
3. LEDs are not designed to be reverse biased.
4. Solder conditions per JEDEC 020c. See Reflow Soldering Profile Figure 3.
5. Autoclave Conditions per JEDEC JESD22-A102-C.
6. LED Engin recommends taking reasonable precautions towards possible ESD damages and handling the LZ4-00R100 in an electrostatic protected area (EPA). An EPA may be adequately protected by ESD controls as outlined in ANSI/ESD S6.1.

Optical Characteristics @ T_C = 25°C

Table 5:

Parameter	Symbol	Typical	Unit
Luminous Flux (@ I_F = 700mA) [1]	Φ_V	440	lm
Luminous Flux (@ I_F = 1000mA) [1]	Φ_V	610	lm
Dominant Wavelength	λ_D	623	nm
Viewing Angle [2]	$2\Theta_{1/2}$	90	Degrees
Total Included Angle [3]	$\Theta_{0.9V}$	115	Degrees

Notes for Table 5:
1. Luminous flux typical value is for all four LED dice operating concurrently at rated current.
2. Viewing Angle is the off axis angle from emitter centerline where the luminous intensity is ½ of the peak value.
3. Total Included Angle is the total angle that includes 90% of the total luminous flux.

Electrical Characteristics @ T_C = 25°C

Table 6:

Parameter	Symbol	Typical	Unit
Forward Voltage (@ I_F = 700mA) [1]	V_F	9.0	V
Forward Voltage (@ I_F = 1000mA) [1]	V_F	9.8	V
Temperature Coefficient of Forward Voltage [1]	$\Delta V_F/\Delta T_J$	-6.5	mV/°C
Thermal Resistance (Junction to Case)	$R\Theta_{J-C}$	1.1	°C/W

Notes for Table 6:
1. Forward Voltage typical value is for all four LED dice connected in series.

IPC/JEDEC Moisture Sensitivity Level

Table 7 - IPC/JEDEC J-STD-20 MSL Classification:

			Soak Requirements			
	Floor Life		Standard		Accelerated	
Level	Time	Conditions	Time (hrs)	Conditions	Time (hrs)	Conditions
1	Unlimited	≤ 30°C/ 85% RH	168 +5/-0	85°C/ 85% RH	n/a	n/a

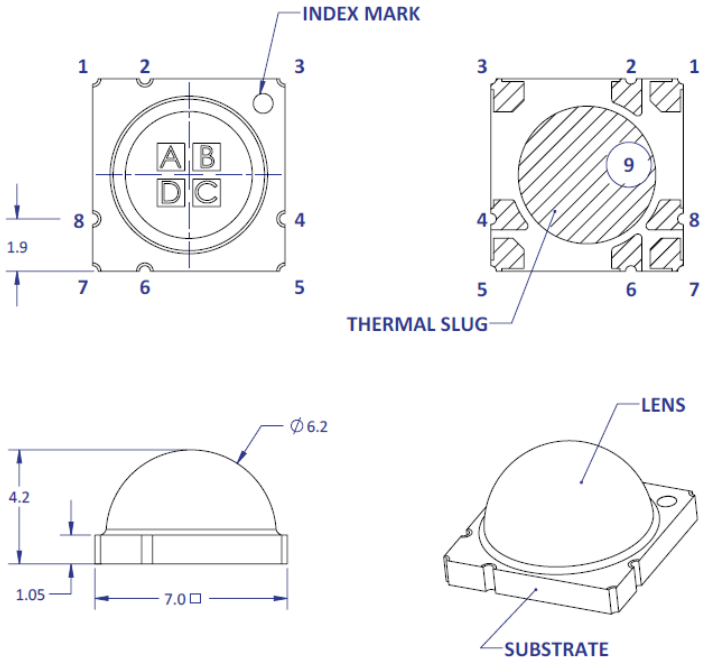
Notes for Table 7:
1. The standard soak time is the sum of the default value of 24 hours for the semiconductor manufacturer's exposure time (MET) between bake and bag and the floor life of maximum time allowed out of the bag at the end user of distributor's facility.

Average Lumen Maintenance Projections

Lumen maintenance generally describes the ability of a lamp to retain its output over time. The useful lifetime for solid state lighting devices (Power LEDs) is also defined as Lumen Maintenance, with the percentage of the original light output remaining at a defined time period.

Based on long-term WHTOL testing, LED Engin projects that the LZ Series will deliver, on average, 70% Lumen Maintenance at 65,000 hours of operation at a forward current of
700 mA per die. This projection is based on constant current operation with junction temperature maintained at or below 110°C.

Mechanical Dimensions (mm)



Pin Out		
Pad	Die	Function
1	A	Anode
2	A	Cathode
3	B	Anode
4	B	Cathode
5	C	Anode
6	C	Cathode
7	D	Anode
8	D	Cathode
9 [2]	n/a	Thermal

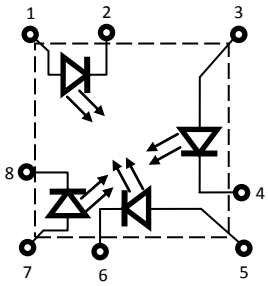


Figure 1: Package outline drawing.

Notes for Figure 1:
1. Unless otherwise noted, the tolerance = ± 0.20 mm.
2. Unless otherwise noted, the tolerance = ± 0.20 mm.

Recommended Solder Pad Layout (mm)

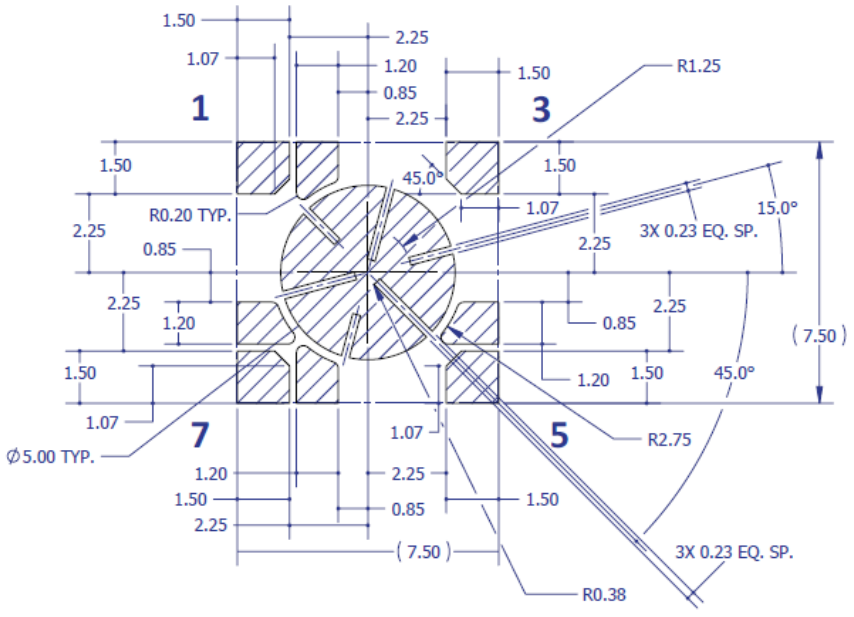


Figure 2a: Recommended solder pad layout for anode, cathode, and thermal pad.

Note for Figure 2a:
1. Unless otherwise noted, the tolerance = ± 0.20 mm.
2. This pad layout is “patent pending”.

Recommended Solder Mask Layout (mm)

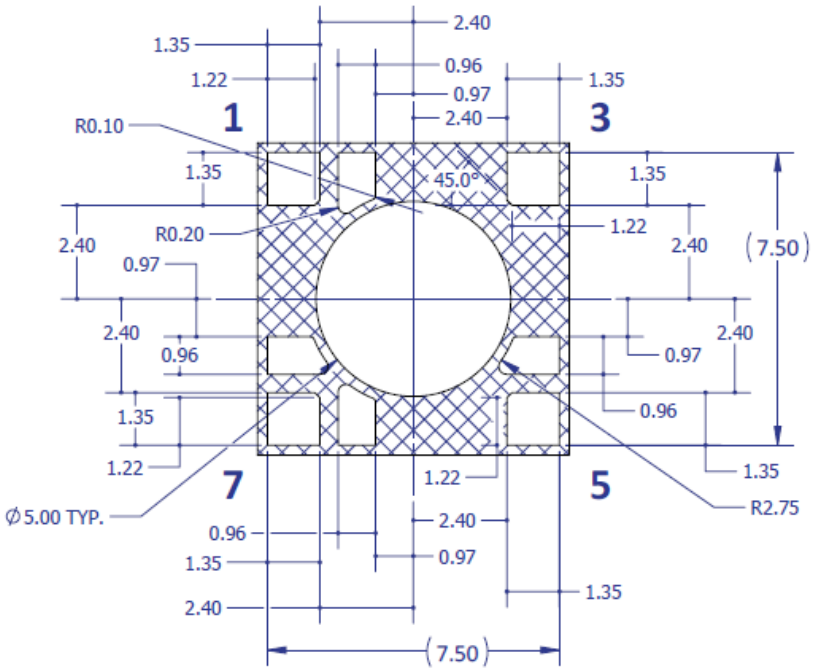


Figure 2b: Recommended solder mask opening (hatched area) for anode, cathode, and thermal pad.

Note for Figure 2b:

1. Unless otherwise noted, the tolerance = ± 0.20 mm.

Reflow Soldering Profile

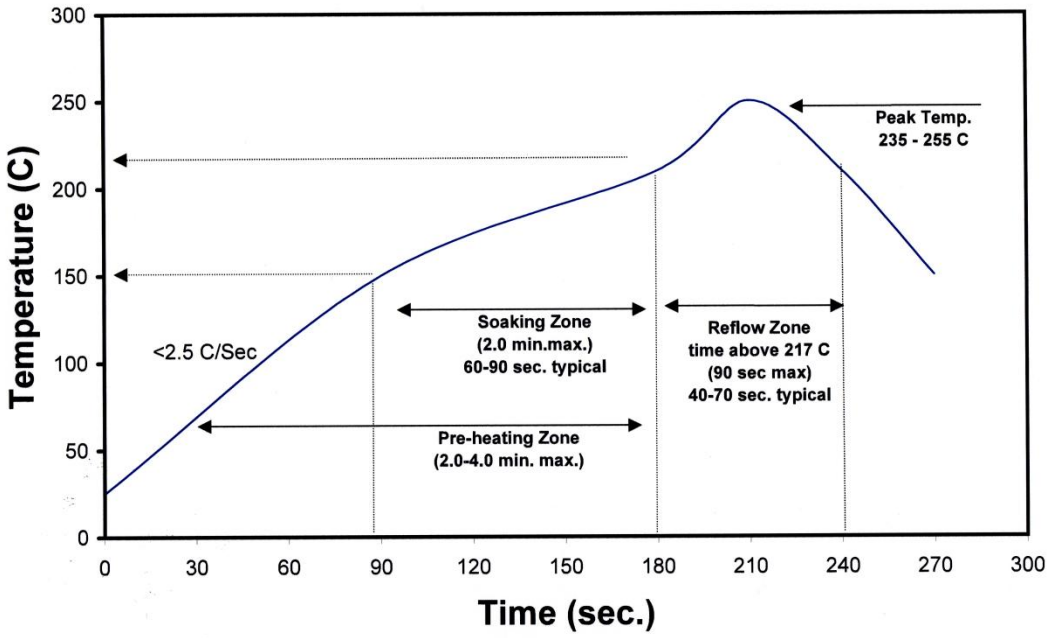


Figure 3: Reflow soldering profile for lead free soldering.

Typical Radiation Pattern

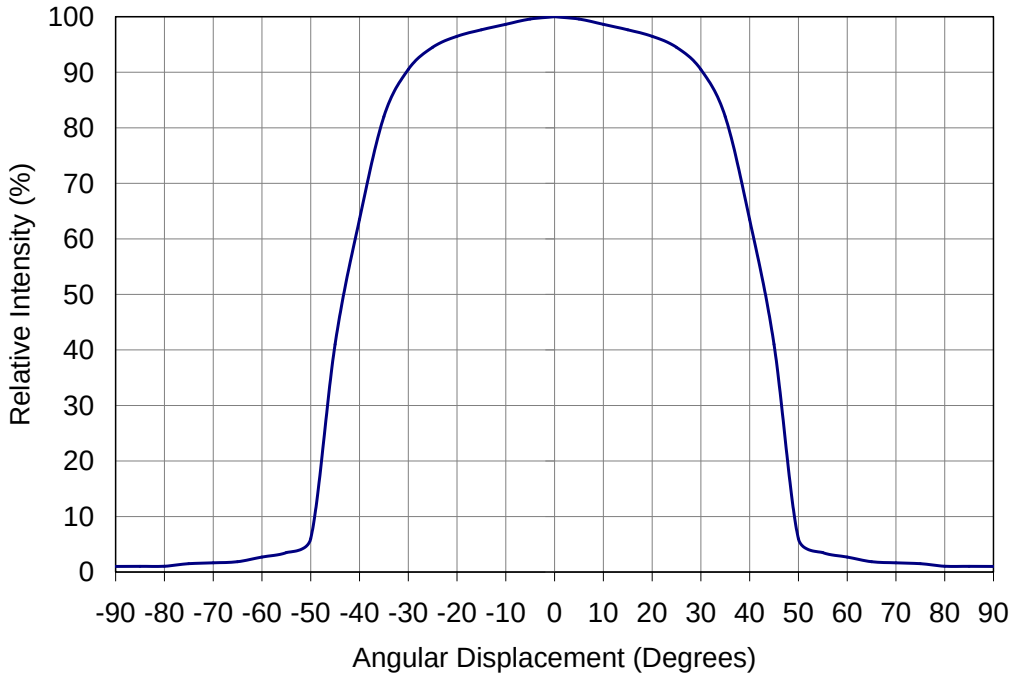


Figure 4: Typical representative spatial radiation pattern.

Typical Relative Spectral Power Distribution

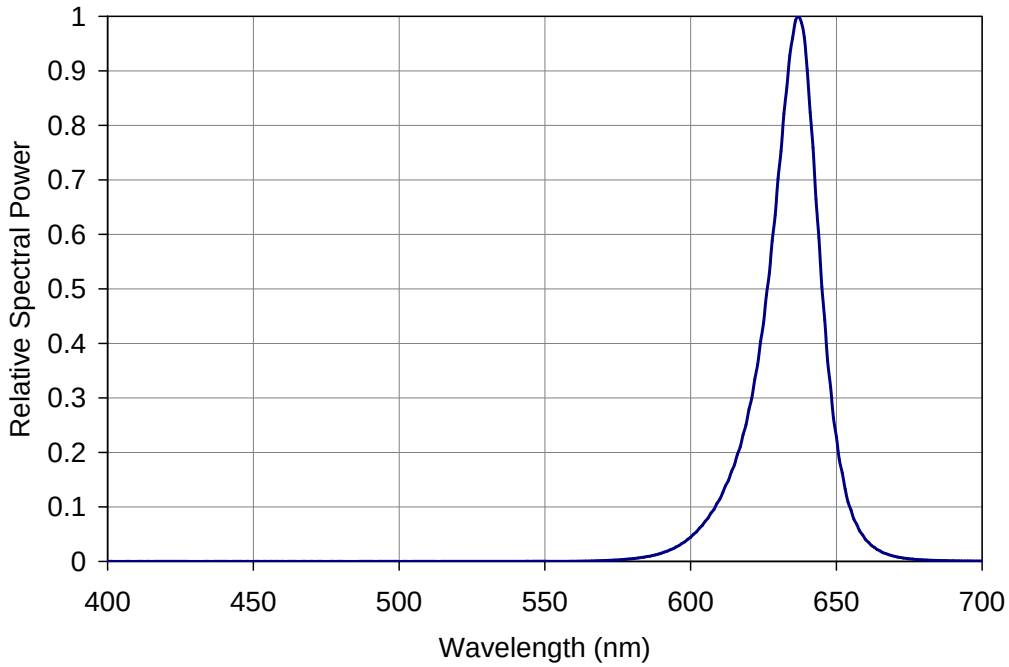


Figure 5: Relative spectral power vs. wavelength @ T_C = 25°C.

Typical Dominant Wavelength Shift over Temperature

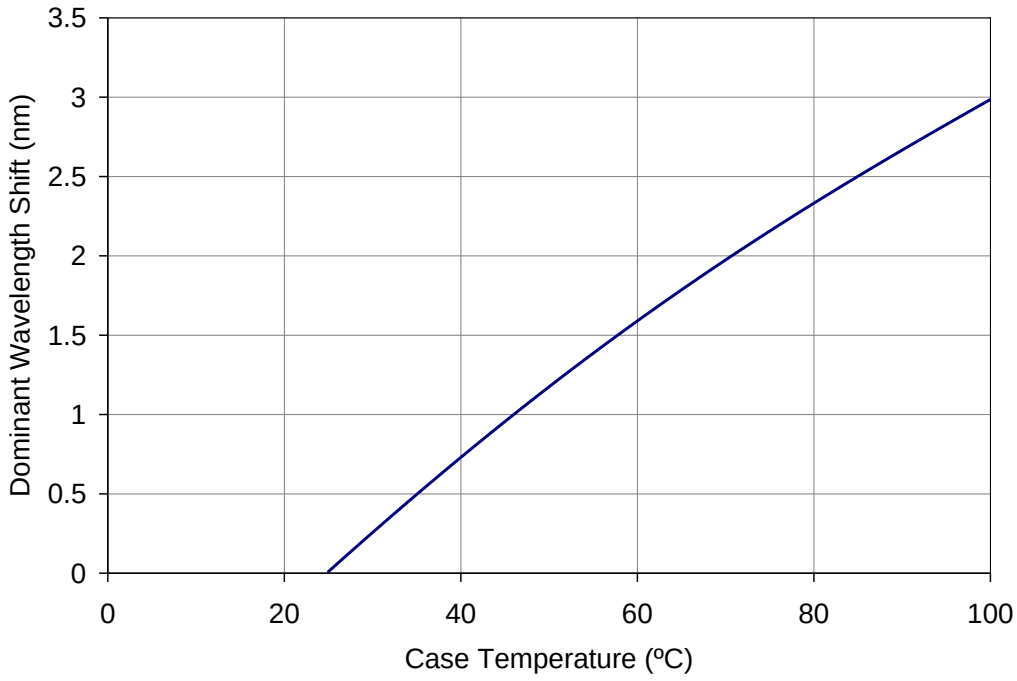


Figure 6: Typical dominant wavelength shift vs. case temperature.

Typical Relative Light Output

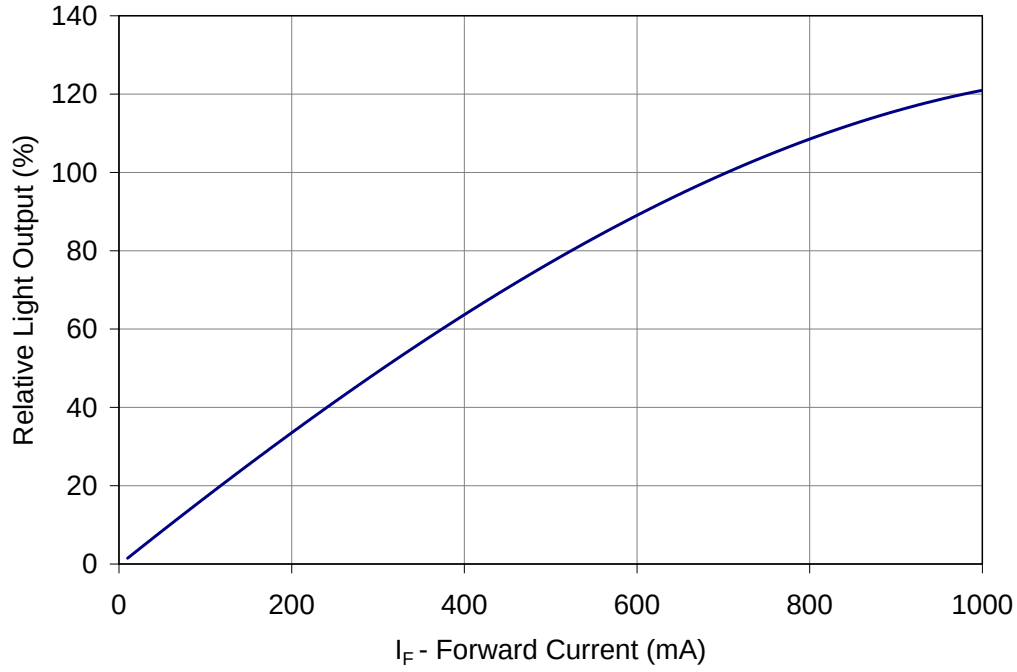


Figure 7: Typical relative light output vs. forward current @ T_c = 25°C.

Typical Relative Light Output over Temperature

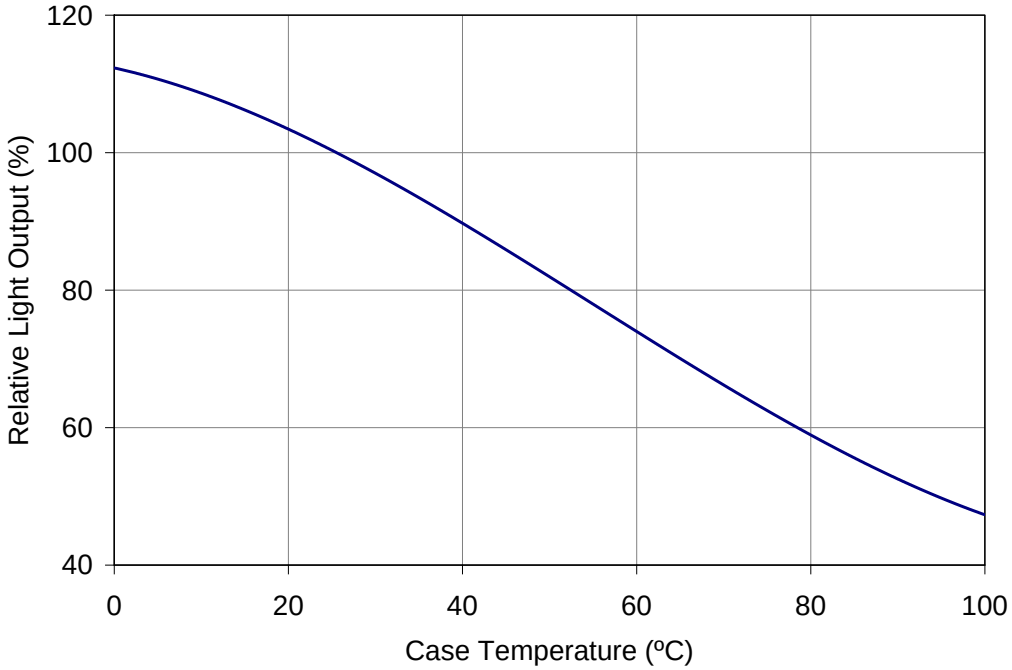


Figure 8: Typical relative light output vs. case temperature.

Typical Forward Current Characteristics

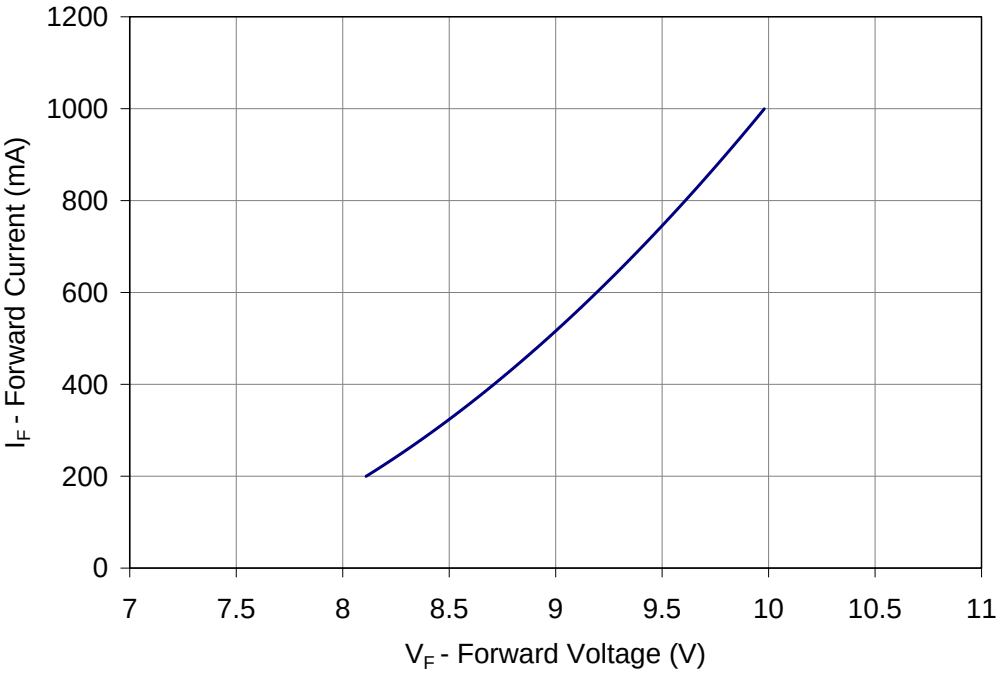


Figure 9: Typical forward current vs. forward voltage @ T_C = 25°C.

Note for Figure 9:
1. Forward Voltage curve assumes that all four LED dice are connected in series.

Current De-rating

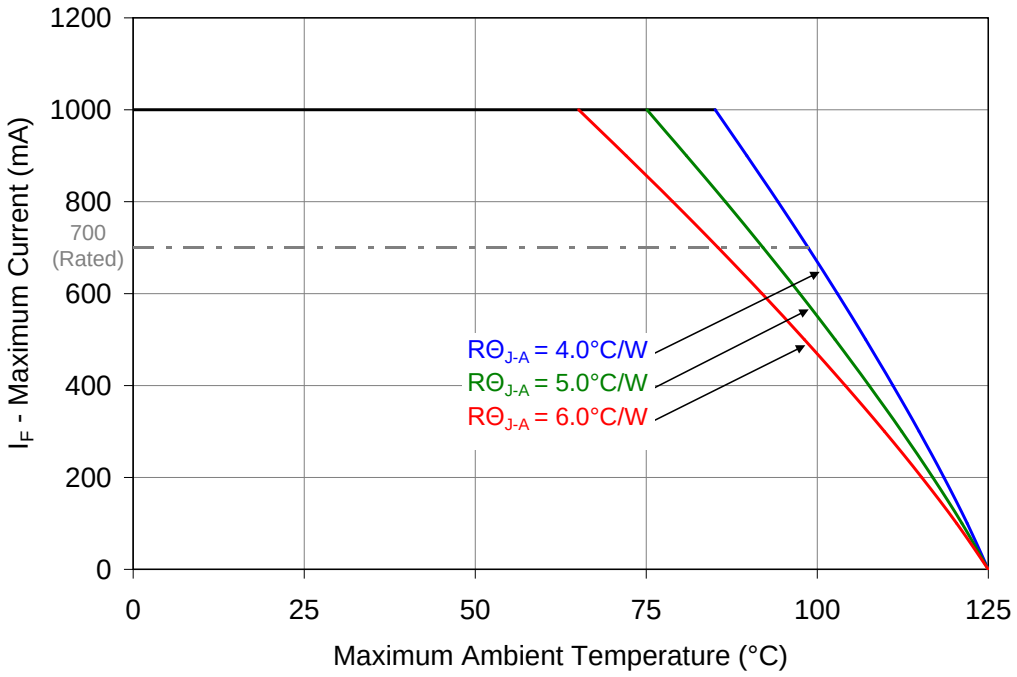


Figure 10: Maximum forward current vs. ambient temperature based on $T_{J(MAX)}$ = 125°C.

Notes for Figure 10:

1. Maximum current assumes that all four LED dice are operating concurrently at the same current.
2. $R\Theta_{J\text{-}C}$ [Junction to Case Thermal Resistance] for the LZ4-00R100 is typically 1.1°C/W.
3. $R\Theta_{J\text{-}A}$ [Junction to Ambient Thermal Resistance] = $R\Theta_{J\text{-}C}$ + $R\Theta_{C\text{-}A}$ [Case to Ambient Thermal Resistance].

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Emitter Tape and Reel Specifications (mm)

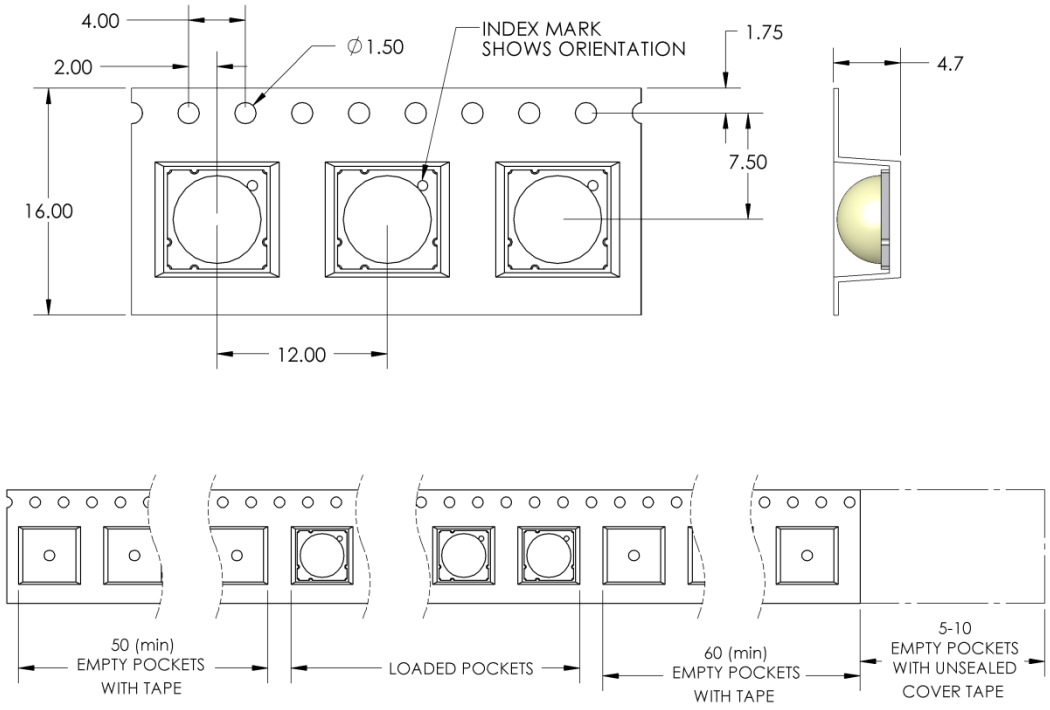


Figure 11: Emitter carrier tape specifications (mm).

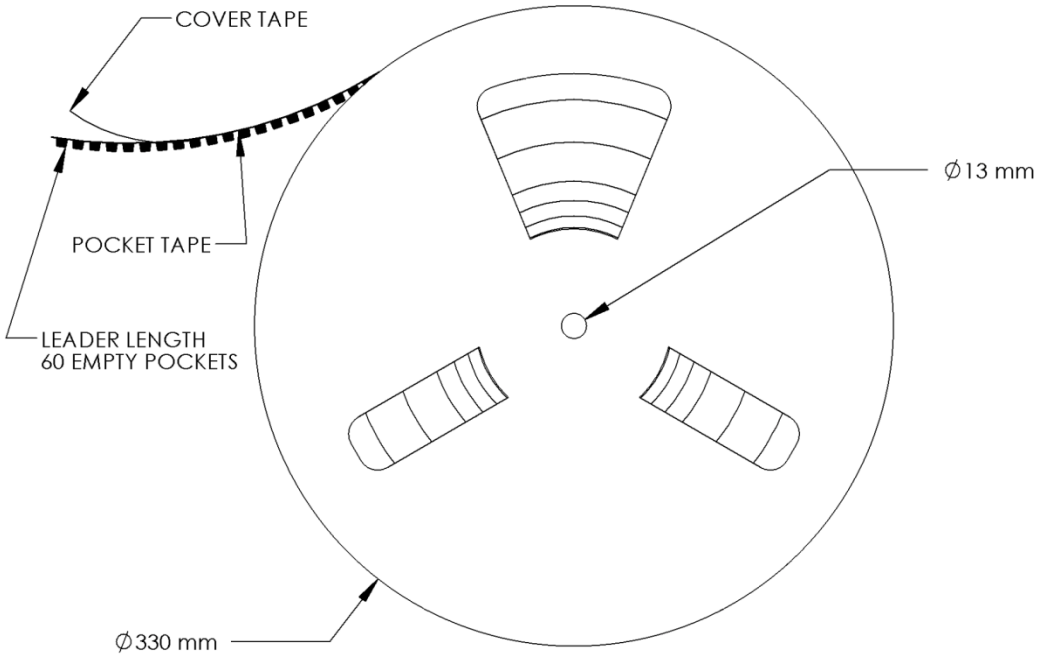


Figure 12: Emitter Reel specifications (mm).

LZ4 MCPCB Family

Part number	Type of MCPCB	Diameter (mm)	Emitter + MCPCB Thermal Resistance (°C/W)	Typical V_f (V)	Typical I_f (mA)
LZ4-4xxxxx	1-channel	19.9	1.1 + 1.1 = 2.2	9.0	700

Mechanical Mounting of MCPCB

- MCPCB bending should be avoided as it will cause mechanical stress on the emitter, which could lead to substrate cracking and subsequently LED dies cracking.
- To avoid MCPCB bending:
  - Special attention needs to be paid to the flatness of the heat sink surface and the torque on the screws.
  - Care must be taken when securing the board to the heat sink. This can be done by tightening three M3 screws (or #4-40) in steps and not all the way through at once. Using fewer than three screws will increase the likelihood of board bending.
  - It is recommended to always use plastics washers in combinations with the three screws.
  - If non-taped holes are used with self-tapping screws, it is advised to back out the screws slightly after tightening (with controlled torque) and then re-tighten the screws again.

Thermal interface material

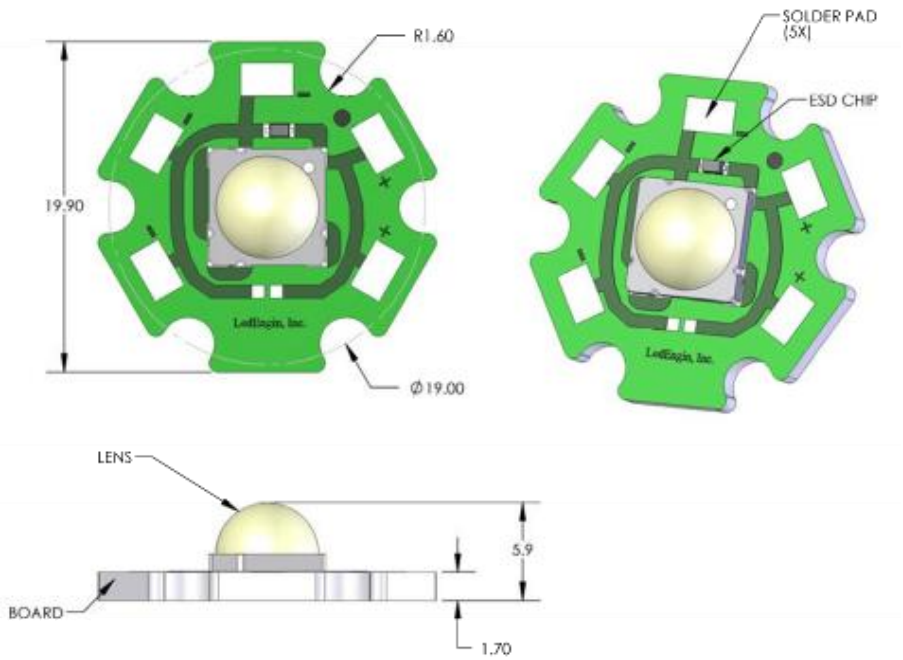
- To properly transfer heat from LED emitter to heat sink, a thermally conductive material is required when mounting the MCPCB on to the heat sink.
- There are several varieties of such material: thermal paste, thermal pads, phase change materials and thermal epoxies. An example of such material is Electrolube EHTC.
- It is critical to verify the material's thermal resistance to be sufficient for the selected emitter and its operating conditions.

Wire soldering

- To ease soldering wire to MCPCB process, it is advised to preheat the MCPCB on a hot plate of 125-150°C. Subsequently, apply the solder and additional heat from the solder iron will initiate a good solder reflow. It is recommended to use a solder iron of more than 60W.
- It is advised to use lead-free, no-clean solder. For example: SN-96.5 AG-3.0 CU 0.5 #58/275 from Kester (pn: 24-7068-7601)

LZ4-4xxxxx

1 channel, Standard Star MCPCB (1x4) Dimensions (mm)



Notes:

- Unless otherwise noted, the tolerance = ± 0.2 mm.
- Slots in MCPCB are for M3 or #4-40 mounting screws.
- LED Engin recommends plastic washers to electrically insulate screws from solder pads and electrical traces.
- Electrical connection pads on MCPCB are labeled "+" for Anode and "-" for Cathode
- LED Engin recommends thermal interface material when attaching the MCPCB to a heatsink
- The thermal resistance of the MCPCB is: RθC-B 1.1°C/W

Components used

MCPCB:	HT04503	(Bergquist)
ESD chips:	BZX585-C30	(NPX, for 4 LED dies in series)

Pad layout			
Ch.	**MCPCB Pad**	**String/die**	**Function**
1	-	1/ABCD	Cathode -
	+		Anode +

Company Information

LED Engin, Inc., based in California's Silicon Valley, specializes in ultra-bright, ultra compact solid state lighting solutions allowing lighting designers & engineers the freedom to create uncompromised yet energy efficient lighting experiences. The LuxiGen™ Platform — an emitter and lens combination or integrated module solution, delivers superior flexibility in light output, ranging from 3W to 90W, a wide spectrum of available colors, including whites, multi-color and UV, and the ability to deliver upwards of 5,000 high quality lumens to a target. The small size combined with powerful output allows for a previously unobtainable freedom of design wherever high-flux density, directional light is required. LED Engin's packaging technologies lead the industry with products that feature lowest thermal resistance, highest flux density and consummate reliability, enabling compact and efficient solid state lighting solutions.

LED Engin is committed to providing products that conserve natural resources and reduce greenhouse emissions.

LED Engin reserves the right to make changes to improve performance without notice.

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